

# CRF02

Power Supply Applications  
Strobo Flasher Applications

Unit: mm

- Repetitive peak reverse voltage :  $V_{RRM} = 800\text{ V}$
- Average forward current :  $I_F (AV) = 0.5\text{ A}$
- Peak forward voltage :  $V_{FM} = 3\text{ V (max)}$
- Very fast reverse-recovery time:  $t_{rr} = 100\text{ ns (max.)}$
- Small, thin package suitable for high-density board assembly  
Toshiba Nickname: "S-FLAT™"

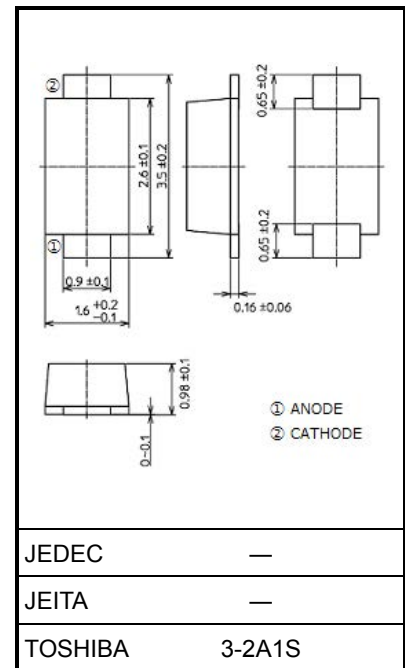
## Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	$V_{RRM}$	800	V
Average forward current	$I_F (AV)$	0.5 (Note 1)	A
Non-repetitive peak forward surge current	$I_{FSM}$	10 (50 Hz)	A
Junction temperature	$T_j$	-40 to 150	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-40 to 150	$^\circ\text{C}$

Note 1:  $T_a = 84^\circ\text{C}$  Device mounted on a ceramic board  
 Board size : 50 mm × 50 mm  
 Soldering land size : 2 mm × 2 mm  
 Board thickness : 0.64 mm  
 Rectangular waveform :  $\alpha = 180^\circ$

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 0.013 g (typ.)

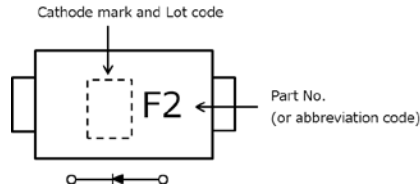
## Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM}$	$I_{FM} = 0.5\text{ A (pulse test)}$	—	2.2	3.0	V
Repetitive peak reverse current	$I_{RRM} (1)$	$V_{RRM} = 400\text{ V (pulse test)}$	—	—	3.0	$\mu\text{A}$
	$I_{RRM} (2)$	$V_{RRM} = 800\text{ V (pulse test)}$	—	—	50	
Reverse recovery time	$t_{rr}$	$I_F = 1\text{ A, di/dt} = -30\text{ A}/\mu\text{s}$	—	—	100	ns
Thermal resistance (junction to ambient)	$R_{th(j-a)}$	Device mounted on a ceramic board board size : 50 mm × 50 mm soldering land size : 2 mm × 2 mm board thickness : 0.64 mm	—	—	70	$^\circ\text{C/W}$
		Device mounted on a glass-epoxy board board size : 50 mm × 50 mm soldering land size : 6 mm × 6 mm board thickness : 1.6 mm	—	—	140	
		Device mounted on a glass-epoxy board board size : 50 mm × 50 mm soldering land size : 1.2 mm × 1.2 mm board thickness : 1.6 mm	—	—	240	
Thermal resistance (junction to lead)	$R_{th(j-t)}$	—	—	—	20	$^\circ\text{C/W}$

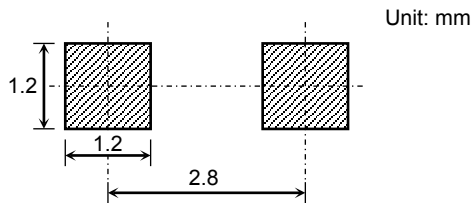
Start of commercial production  
2003-12

## Marking

Abbreviation Code	Part No.
F2	CRF02



## Land pattern dimensions for reference only



## Handling Precaution

- 1) The absolute maximum ratings denote the absolute maximum ratings, which are rated values that must not be exceeded during operation, even for an instant. The following are the general derating methods that we recommend for when designing a circuit incorporating this device.

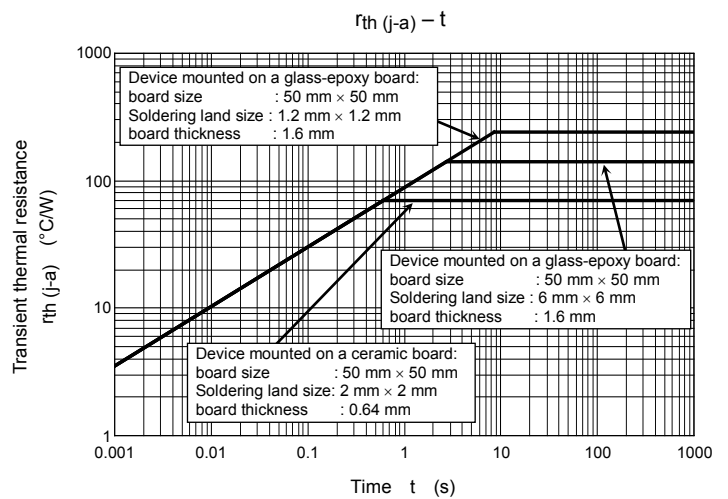
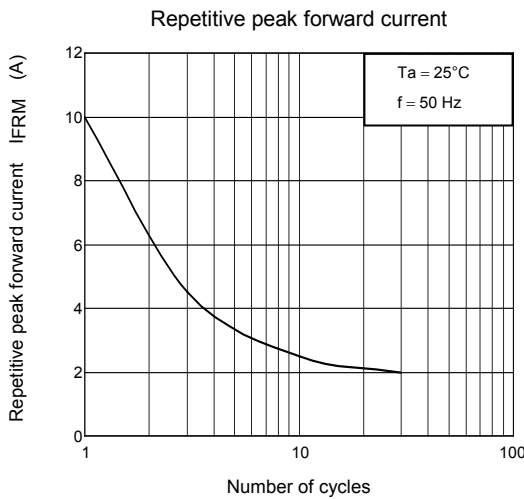
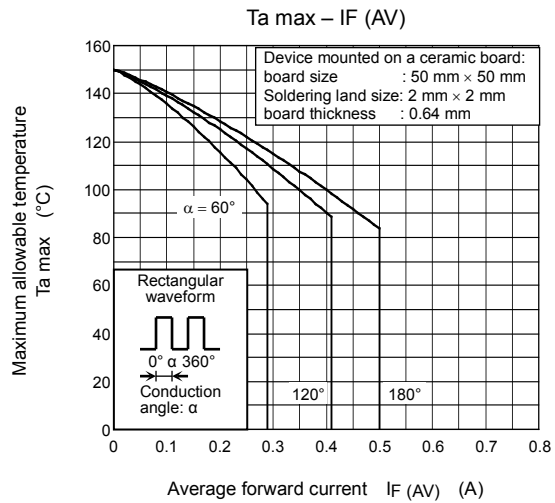
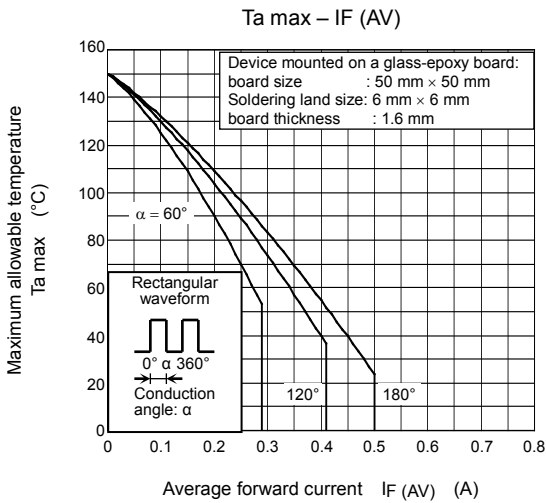
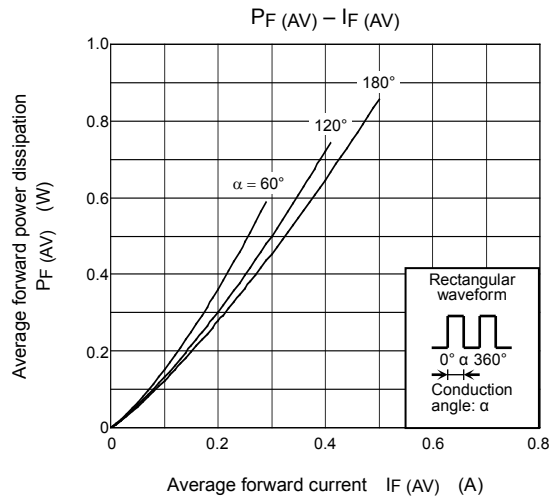
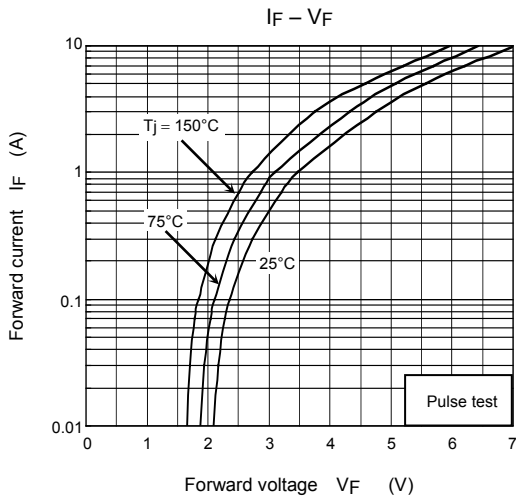
$V_{RRM}$ : We recommend that the worst case voltage, including surge voltage, be no greater than 80% of the absolute maximum rating of  $V_{RRM}$  for a DC circuit and no greater than 50% of that of  $V_{RRM}$  for an AC circuit.  $V_{RRM}$  has a temperature coefficient of 0.1%/°C. Take this temperature account coefficient into when designing a device for operation at low temperatures.

$I_{F(AV)}$ : We recommend that the worst-case current be no greater than 80% of the absolute maximum rating of  $I_{F(AV)}$  and that the worst-case junction temperature,  $T_j$ , be kept below 120°C. When using this device, allow margins, referring to the  $T_{a(max)} - I_{F(AV)}$  curve.

$I_{FSM}$ : This rating specifies peak non-repetitive forward surge current. This only applies to an abnormal operation, which seldom occurs during the lifespan of a device.

$T_j$ : Derate device parameters in proportion to this rating in order to ensure high reliability. We recommend that the junction temperature ( $T_j$ ) of a device be kept below 120°C.

- 2) Thermal resistance (junction-to-ambient) varies with the mounting conditions of a device on a circuit board. An appropriate thermal resistance value should be used, considering the heat sink, circuit board design and soldering land size.
- 3) For other design considerations, see the Rectifiers databook or the Toshiba website.



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